

#### **60V DUAL PNP SMALL SIGNAL TRANSISTOR IN SOT363**

#### **Features**

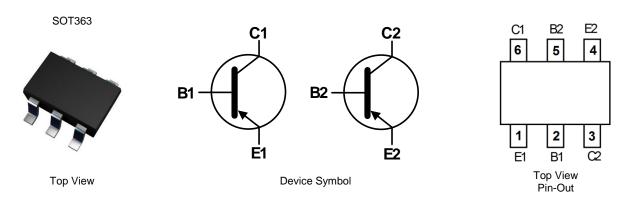
- Ultra-Small Surface Mount Package
- Epitaxial Planar Die Construction
- Ideal for Low Power Amplification and Switching
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

- This part is qualified to JEDEC standards (as references in AEC-Q101) for High Reliability.
- https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Finish. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.006 grams (Approximate)



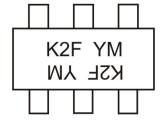
#### Ordering Information (Note 4)

Product	Status	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	<b>Quantity Per Reel</b>
MMDT2907A-7-F	Active	Standard	K2F	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

#### **Marking Information**



 $\begin{array}{l} \text{K2F} = \text{Product Type Marking Code} \\ \text{YM} = \text{Date Code Marking} \\ \text{Y or } \overline{\text{Y}} = \text{Year (ex: G} = 2019) \\ \text{M or } \overline{\text{M}} = \text{Month (ex: 9} = \text{September)} \end{array}$ 

Date Code Key

Year	2018	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	F	G	Н		J	K	L	М	N	0	Р	Q
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	Ω	N	D



### Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-60	V
Emitter-Base Voltage	$V_{EBO}$	-5.0	V
Collector Current	Ic	-600	mA

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

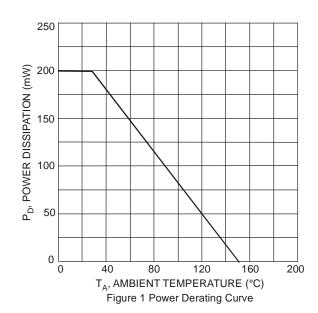
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	200	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	R <sub>0JA</sub>	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

# ESD Ratings (Note 6)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

### **Thermal Characteristics and Derating Information**



<sup>5.</sup> For the device mounted on minimum recommended pad layout FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

6. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

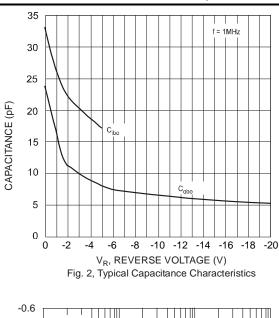
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-60	1	I	V	$I_C = -10\mu A, I_B = 0$
Collector-Emitter Breakdown Voltage (Note 7)	BV <sub>CEO</sub>	-60	_		V	$I_C = -10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	$BV_{EBO}$	-5	1	I	V	$I_E = -10\mu A, I_C = 0$
Collector Cutoff Current	1	1	1	-10	nA	$V_{CB} = -50V, I_{E} = 0$
Collector Cuton Current	I <sub>CBO</sub>	_	_	-10	μΑ	$V_{CB} = -50V, I_E = 0, T_A = +125^{\circ}C$
Collector Cutoff Current	ICEX	_	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$
Base Cutoff Current	$I_{BL}$		_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$
ON CHARACTERISTICS (Note 7)						
		75	_	_		$I_C = -100 \mu A$ , $V_{CE} = -10 V$
		100	_	_		$I_C = -1.0 \text{mA}, V_{CE} = -10 \text{V}$
DC Current Gain	h <sub>FE</sub>	100	_	_	_	$I_C = -10 \text{mA}, V_{CE} = -10 \text{V}$
		100	_	300		$I_C = -150 \text{mA}, V_{CE} = -10 \text{V}$
		50				$I_C = -500 \text{mA}, V_{CE} = -10 \text{V}$
Collector-Emitter Saturation Voltage	Voe	at) —		-0.4	V	$I_C = -150 \text{mA}, I_B = -15 \text{mA}$
Collector-Efflitter Saturation Voltage	V <sub>CE(sat)</sub>			-1.6		$I_C = -500 \text{mA}, I_B = -50 \text{mA}$
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	_	_	-1.3	V	$I_C = -150 \text{mA}, I_B = -15 \text{mA}$
g .	V BE(sat)			-2.6	V	$I_C = -500 \text{mA}, I_B = -50 \text{mA}$
SMALL SIGNAL CHARACTERISTICS					,	
Output Capacitance	C <sub>OBO</sub>	_	_	8.0	pF	$V_{CB} = -10V$ , $f = 1.0MHz$ , $I_E = 0$
Input Capacitance	C <sub>IBO</sub>	_	_	30	pF	$V_{EB} = -2.0V$ , $f = 1.0MHz$ , $I_C = 0$
Current Gain Bandwidth Product	$f_T$	200	_	_	MHz	$V_{CE} = -20V, I_{C} = -50mA,$ f = 100MHz
SWITCHING CHARACTERISTICS					•	
Turn-On Time	t <sub>off</sub>	-	-	45	ns	\\ 20\\ I 450~ A
Delay Time	t <sub>d</sub>	-	_	10	ns	$V_{CC} = -30V, I_C = -150mA,$
Rise Time	tr		_	40	ns	$I_{B1} = -15 \text{mA}$
Turn-Off Time	t <sub>off</sub>	_	_	100	ns	V 6V 1 450 A
Storage Time	ts	1	1	80	ns	$V_{CC} = -6V, I_C = -150mA,$
Fall Time	t <sub>f</sub>	_	_	30	ns	$I_{B1} = -I_{B2} = -15\text{mA}$

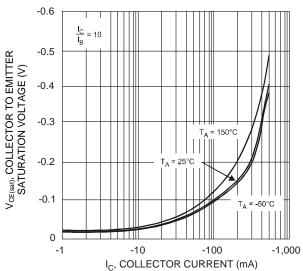
Note:

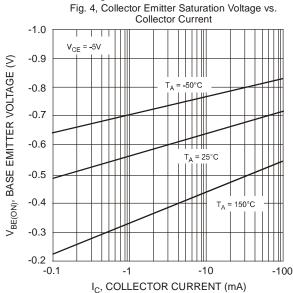
7. Short duration pulse test used to minimize self-heating effect.

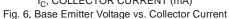


### Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)









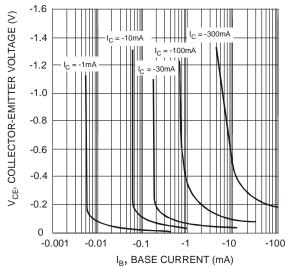


Fig. 3, Typical Collector Saturation Region

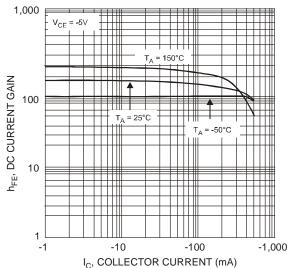


Fig. 5, DC Current Gain vs. Collector Current

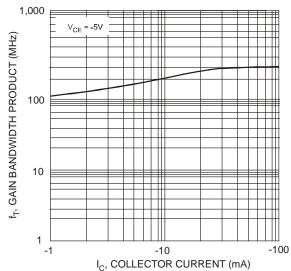


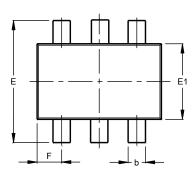
Fig. 7, Gain Bandwidth Product vs.
Collector Current

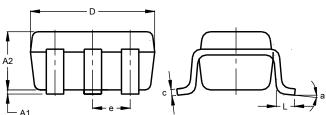


# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT363**



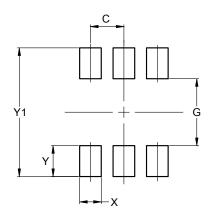


SOT363							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.10	0.30	0.25				
С	0.10	0.22	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
е	C	.650 E	SC				
F	0.40	0.45	0.425				
L	0.25	0.40	0.30				
а	0°	8°					
All I	Dimen	sions	in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT363**



Dimensions	Value			
Dimensions	(in mm)			
С	0.650			
G	1.300			
Х	0.420			
Y	0.600			
Y1	2.500			



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